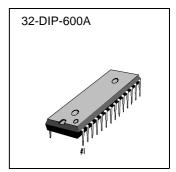
VIDEO AMP MERGED OSD PROCESSOR

The S1D2514X01 is a very high frequency video amplifier & wide range OSD processor 1 chip system with I²C Bus control used in monitors. It contains 3 matched R/G/B video amplifiers with OSD processor and provides flexible interfacing to I²C Bus controlled adjustment systems.



FUNCTIONS

- R/G/B video amplifier
- OSD processor
- I²C bus control
- Cut-off brightness control
- R/G/B sub contrast/cut-off control
- Half tone

FEATURES

VIDEO AMP PART

- 3-channel R/G/B video amplifier, 150MHz @f-3dB
- I²C bus control items
 - Contrast control: -38dB
 - Sub contrast control for each channel: -12dB
 - Brightness control
 - OSD contrast control: -38dB
 - Cut-off brightness control (AC coupling)
 - Cut-off control for each channel (AC coupling)
 - Switch registers for SBLK and video half tone and CLP/BLK polarity selection and INT/EXT CLP selection
- Built in ABL (automatic beam limitation)
- Built in video input clamp, BRT clamp
- Built in video half tone (3mode) function on OSD pictures
- Capable of 8.0Vp-p output swing
- Improvement of rise & fall time (2.2ns)
- Cut-off brightness control
- Built in blank gate with spot killer
- Clamp pulse generator
- OSD intensity
- BLK, CLP polarity selection
- Clamp gate with anti OSD sagging

ORDERING INFORMATION

Device	Package	Operating Temperature
S1D2514X01-D0B0	32-DIP-600A	-20 °C − +75 °C

OSD PART

- Built in 1K-byte SRAM
- 256 ROM fonts (each font consists of 12 × 18 dots.)
- Full screen memory architecture
- Wide range PLL available (15kHz 90kHz, Reference 800 X 600)
- Programmable vertical height of character
- Programmable vertical and horizontal positioning
- Character color selection up to 16 different colors (in a units of character)
- Programmable background color (up to 16 colors)
- Character blinking and shadowing
- Character scrolling
- 72MHz pixel frequency from on-chip PLL (Reference 800 ± 600)
- Full white pattern generation function



BLOCK DIAGRAM

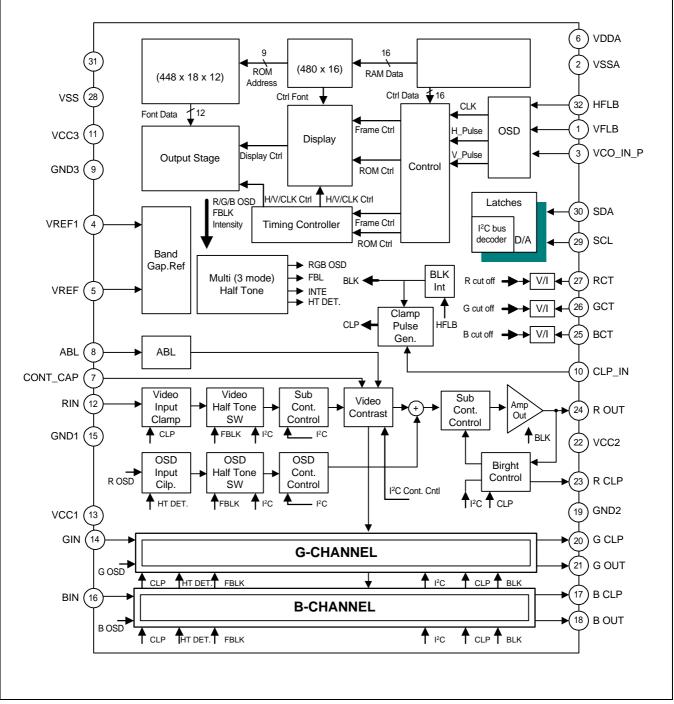


Figure 1. Functional Block Diagram



PIN CONFIGURATION

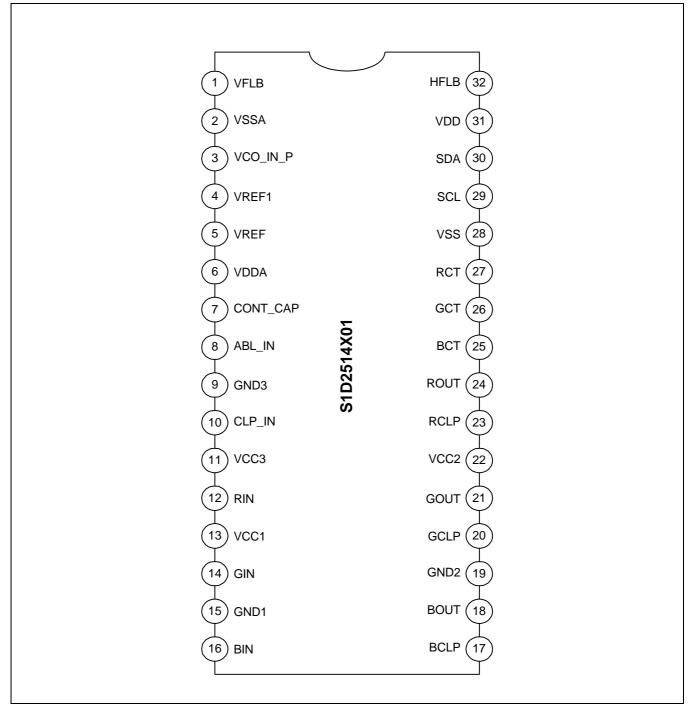


Figure 2. Pin Configuration



Pin No.	Symbol	I/O	Configuration
1	VFLB	I	Vertical flyback signal
2	VSSA	-	Ground (PLL part)
3	VCO_IN_P	I	This voltage is generated at the external loop filter and goes into the input stage of the VCO.
4	VREF1	0	Charge pump output
5	VREF	0	PLL regulator filter
6	VDDA	-	+5V supply voltage for PLL part
7	CONT_CAP	-	Contrast control for AMP part
8	ABL	-	Auto beam limit.
9	GND3	-	Ground for video AMP part(for AMP control)
10	CLP_IN	-	Video clamp pulse input
11	VCC3	-	+12V supply voltage for video AMP part(for AMP control)
12	RIN	I	Video signal input (red)
13	VCC1	-	+12V supply voltage for video AMP(for main video signal process)
14	GIN	I	Video signal input (green)
15	GND1	-	Ground for video AMP part(for main video signal process)
16	BIN	I	Video signal input (blue)
17	BCLP	-	B output clamp cap
18	BOUT	0	Video signal output (blue)
19	GND2	-	Ground for video AMP part(for video output drive)
20	GCLP	-	G output clamp cap
21	GOUT	0	Video signal output (green)
22	VCC2	-	+12V supply voltage for video AMP part(for video output drive)
23	RCLP	-	R output clamp cap
24	ROUT	0	Video signal output (red)
25	BCT	-	B cut-off output
26	GCT	-	G cut-off output
27	RCT	-	R cut-off output
28	VSS	-	Ground for digital part
29	SCL	I	Serial clock (I ² C)
30	SDA	I/O	Serial data (I ² C)
31	VDD	-	+5V supply voltage for digital part
32	HFLB	I	Horizontal flyback signal

Table 1. Pin Configuration



PIN DESCRIPTION

Pin No	Pin Name	Schematic	Description
1	VFLB	VFLB	FLB signal is in TTL level
32	HFLB		Multi polarity input
3	VCO_IN_P	Ľ,	PLL loop filter output
4	VPEF1		BandGap ref. output
5	VREF	 ↓	
7	Contrast cap (CONT_CAP)	I ² C Data → 4.0K Vref ↓ 100µ A	Contrast cap range (0.1uF — 5uF)
8	ABL_IN	Vref VCC 100K Vref Vref Vref 250µA	ABL input DC range (1 — 4.5V)

Table 2. Pin Description



Pin No	Pin Name	Schematic	Description
10	CLP_IN	VCC 50K	Multi polarity input Clamp gate pulse TTL level input
12	Red video input (RIN)	vcc Vcc	Max input video signal is 0.7 Vpp
14	Green video input (GIN)		
16	Blue video input (BIN)	Video_In O.2K	
17	Blue (B clamp cap)	Ţ.	Brightness controlling actives by charging and discharging of the external cap. (0.1µF)
20	Green (G clamp cap)	0.2K €	(During clamp gate)
23	Red (R clamp)	0.2K	

Table 2. Pin Description (Continued)



Pin No	Pin Name	Schematic	Description
18	Blue video output (BOUT)	VCC Ţ ξ 0.05К	Video signal output
21	Green video output (GOUT)	0.5K	
24	Red video output (ROUT)	♥ Isink	
27	Red cut-off control (RCT)		Cut-off control output
26	Green cut-off control (GCT)	0-600uA 0-200uA 50uA 100uA	
25	Blue cut-off control (BCT)	$\diamond \diamond \diamond \diamond$	
29	SCL		Serial clock input port of I ² C bus
30	SDA	SDA	Serial data input port of I ² C bus

Table 2. Pin Description (Continued)



S1D2514X01

ABSOLUTE MAXIMUM RATINGS (see 1)

(Ta = 25 °C)

No	lien	Symbol	Value			11	
No	Item		Min	Тур	Max	Unit	
1	Maximum supply voltage	V _{CC}	-	-	13.2	v	
I	Maximum supply voltage	V _{DD}	-	-	6.5		
2	Operating temperature (see 2)	Topr	-20	-	75	°C	
3	Storage temperature	Tstg	-65		150	°C	
4	Operating supply voltage	V _{CCop}	11.4	12.0	12.6	V (see 3)	
	V _{DDop}	4.75	5.00	5.25			
5	Power dissipation	P _D	-	-		W	

Table 3. Absolute Maximum Ratings

THERMAL & ESD PARAMETER

Table 4. Thermal & ESD Parameter

No	Item	Symbol		Unit		
NO	item	Symbol	Min	Тур	Мах	Unit
1	Thermal resistance (junction-ambient)	θја	-	48	-	°C/W
2	Junction temperature	Tj	-	150	-	°C
3	Human body model (C = 100p, R = 1.5k)	HBM	2	-	-	KV
4	Machine model (C = 200p, R = 0)	MM	300	-	-	V
5	Charge device model	CDM	800	-	-	V



ELECTRICAL CHARACTERISTICS

DC ELECTRICAL CHARACTERISTICS

(Tamb = 25 °C, V_{CC} = 12V, V_{DD} = V_{DDA} = 5V, ABL input voltage = 5V, HFLB input signal = S3, load resistors = 470Ω , except OSD part current 35mA, unless otherwise stated)

Deserveter	Cumhal	Conditions	Value			11
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Supply current	I _{CC} ^(see 4)		100	125	130	mA
Minimum supply current	I _{CC} min	V _{CC} = 11.4V	95	110	120	mA
Maximum supply current	I _{CC} max	V _{CC} = 12.6V	105	130	140	mA
ABS supply current	I _{CC} abs	V _{CC} = 13.2V	-	-	175	mA
Video input bias voltage	V bias		1.8	2.1	2.4	V
Video black level voltage (POR)	V blackpor		1.20	1.50	1.80	V
Black level voltage channel difference (POR)	Δ V blackpor (see 5)		Δ 10	-	-	%
Video black level voltage (FFH)	V blackff	04 = FFH ^(see 13)	2.2	2.7	3.2	V
Black level voltage channel difference (FFH)	Δ V blackff		Δ 10	-	-	%
Video black level voltage (00H)	V black00	04 = 00H	-	0.2	0.5	V
Black level voltage channel difference (00H)	Δ V black00		Δ10	-	-	%
Spot killer voltage	Vspot	V _{CC} = Var.	9.20	10.4	11.2	V
Cut-off current (FFH)	ICTff	Pin25, 26, 27 = 12V 09 — 0B: FFH 0C: 00H	500	625	750	μA
Cut-off current (00H)	ICT00	Pin25, 26, 27 = 12V 09 — 0C: 00H	-	2.0	5.0	μA
Cut-off brightness current (FFH)	ICTBRTff	Pin25, 26, 27 = 12V 09 — 0B: 00H 0C: FFH	100	180	260	μA
Cut-off brightness current (80H)	ICTBRT80	Pin25, 26, 27 = 12V 09 — 0B: 00H 0C: 80H	50	90	130	μA
Cut-off offset current 1	ICS1	Pin25, 26, 27 = 12V 09 — 0C: 00H 0E: 11H	25	50	75	μΑ

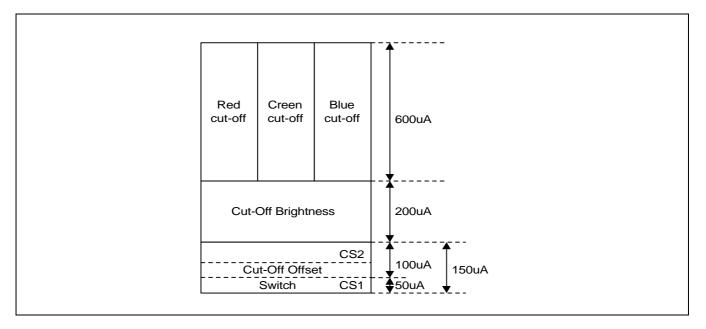
Table 5. DC Electrical Characteristics



Table 5. DC Electrical	Characteristics	(Continued)
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Parameter	Symbol	Conditions	Value			Unit
Falameter	Symbol	Conditions	Min	Тур		Unit
Cut-off offset current 2	ICS2	Pin25, 26, 27 = 12V 09 — 0C: 00H 0E: 12H	50	100	130	μA
Soft BLK output voltage	Vsblk	0D: 80H 0E: 14H	-	0.2	0.5	V
Clamp cap voltage (POR)	Vcap		6.0	7.0	8.0	V

Total external cut-off current range





AC ELECTRICAL CHARACTERISTICS

(Tamb = 25 °C, V_{CC} = 12V, V_{DD} = V_{DDA} = 5V, ABL input voltage = 5V, HFLB input signal = S3, load resistors = 470Ω , Vin = 0.7Vpp manually adjust video output pins 18, 21 and 24 to 4V DC for the AC test (see 11) unless otherwise stated ^(see 12))

Deremeter	Symbol	Conditions	Value			11
Parameter	Symbol	Conditions	Min	Тур	Max 6.4 - 3.2 - -4 2.9 - 1.9 - -10 -8 2.8 12.0 15.0 - -20 -10 1	Unit
Contrast max. output voltage	Vcff	03, 05, 06, 07 = FFH	5.0	5.7	6.4	Vpp
Contrast max. output channel difference	Δ Vcff	04, 08 — 0C = 80H RGB input = S1	Δ10	-	-	%
Contrast center output voltage	Vc80	03, 04, 08 — 0C = 80H	2.5	2.85	3.2	Vpp
Contrast center output channel difference	Δ Vc80	05, 06, 07 = FFH RGB input = S1	Δ10	-	-	%
Contrast max Center attenuation	С	C = 20log (Vc80/Vcff)	-8	-6	-4	dB
Sub contrast center output voltage	Vd80	03 = FFH	2.3	2.6	2.9	Vpp
Sub contrast center output channel difference	Δ Vd80	04 — 0C = 80H RGB input = S1 03 = FFH, 05— 07: 00H	Δ10	-	-	%
Sub contrast min. output voltage	Vd00	-	1.3	1.6	1.9	Vpp
Sub contrast min. output channel difference	Δ Vd00	04, 08 — 0C = 80H RGB input = S1	Δ 10	-	-	%
Sub contrast max min. attenuation	D	D = 20log (Vd00/Vcff)	-14	-12	-10	dB
ABL control range	ABL	(see 15)	-12	-10	-8	dB
R/G/B video rising time (see 7)	tr (video)	03, 05 — 07: FFH	-	2.2	2.8	ns
R/G/B video falling time (see 7)	tf (video)	$\begin{array}{c} 04, 08 - 0C = 80H\\ RGB input = S1\\ 03, 04, 08 - 0C = 80H\\ 05, 06, 07 = FFH\\ RGB input = S1\\ \hline C = 20log (Vc80/Vcff)\\ 03 = FFH\\ 04 - 0C = 80H\\ RGB input = S1\\ \hline 03 = FFH, 05 - 07: 00H\\ 04, 08 - 0C = 80H\\ RGB input = S1\\ \hline D = 20log (Vd00/Vcff)\\ (see 15)\\ \hline 03, 05 - 07: FFH\\ 04, 08 - 0C: 80H\\ RGB input = S2\\ \hline POR\\ HFLB: S4\\ \hline (see 16)\\ (see 17)\\ \hline (see 18)\\ \hline 5)\\ \hline \end{array}$	-	2.2	2.8	ns
R/G/B blank output rising time (see 7)	tr (blank)		-	6.0	12.0	ns
R/G/B blank output falling time (see 7)	tf (blank)	03 = FFH 04 0C = 80H RGB input = S1 03 = FFH, 05 07: 00H 04, 08 0C = 80H RGB input = S1 D = 20log (Vd00/Vcff) (see 15) 03, 05 07: FFH 04, 08 0C: 80H RGB input = S2 POR HFLB: S4 (see 16) (see 17)	-	8.0	15.0	ns
R/G/B video band width ^(see 7, 8)	f (-3dB)	(see 16)	150	-	-	MHz
Video AMP 50MHz cross talk	CT_50M (see7, 9)	(see 17)	-	-25	-20	dB
Video AMP 130MHz cross talk	CT_130M (see7, 9)	(see 18)	-	-15	-10	dB
Absolute gain match	Avmatch (see 6)		-1	-	1	dB
Gain change between amplifier	Avtrack (see 7)		-1	-	1	dB

 Table 6. AC Electrical Characteristics



OSD ELECTRICAL CHARCTERISTICS

(Tamb = 25 °C, V_{CC} = 12V, V_{DD} = V_{DDA} = 5V, HFLB input voltage = S3, load rosistors = 470 Ω , V-AMP test registors FBLK, OSD input conditions unless otherwise stated)

Devemeter	Symbol Conditions		Value		Unit	
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
OSD contrast max. output voltage	Vocff	08 = FFH	5.4	6.4	7.4	Vpp
OSD contrast max. output channel difference	Δ Vocff	OSD RGB output conditions	Δ 10	-	-	%
OSD contrast center output voltage	Voc80	08 = 80H	2.7	3.2	3.7	Vpp
OSD contrast center output channel difference	Δ Voc80	OSD RGB output conditions	Δ 10	-	-	%
R/G/B OSD rising time	tr (OSD)	08: FFH	-	4.0	5.0	ns
R/G/B OSD falling time	tf (OSD)		-	4.0	5.0	ns
HT video level	HTvideo	ABL = 6V	-6.0	-4.5	-3.0	dB
HT video output channel difference	∆ HTvideo	RGB input = S1 03, 05 — 08: FFH 0D: 01H OSD black conditions input HTvideo = 20log(V _{htvideo} /V _{cff})	Δ 15	-	-	%
HT OSD level	HTosd	ABL = 6V	-7.0	-5.5	-4.0	dB
HT OSD output channel difference	∆ HTosd	 05 — 08: FFH 0D: 0FH OSD white condition input HTosd = 20log (V_{htosd}/V_{ocff}) 	Δ 15	-	-	%

Table 7. OSD Electrical Chaacteristics



OPERATION TIMINGS

Table 8. Operation Timings						
Parameter	Symbol	Min	Тур	Max	Unit	
Input Signal HFLB, VFLB			•		•	
Horizontal flyback signal frequency	f _{HFLB}	-	-	120	kHz	
Vertical flyback signal frequency	f _{VFLB}	-	-	200	Hz	
I ² C Interface SDA, SCL (Refer to Figu	ıre 3)					
SCL clock frequency	f _{SCL}	-	-	300	kHz	
Hold time for start condition	t _{hs}	500	-	-	ns	
Set up time for stop condition	t _{sus}	500	-	-	ns	
Low duration of clock	t _{low}	400	-	-	ns	
High duration of clock	t _{high}	400	-	-	ns	
Hold time for data	t _{hd}	0	-	-	ns	
Set up time for data	t _{sud}	500	-	-	ns	
Time between 2 access	t _{ss}	500	-	-	ns	
Fall time of SDA	t _{fSDA}	-	-	20	ns	
Rise time of both SCL and SDA	t _{rSDA}	-	-	-	ns	

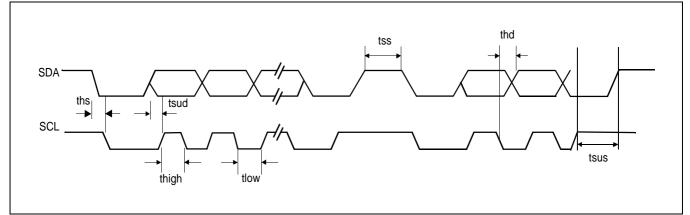


Figure 3. I²C Bus Timing Diagram



OSD PART DC ELECTRICAL CHARACTERISTICS

 $(Ta = 25 C, V_{DDA} DD = 5V)$

Parameter	Symbol		Тур	Max	
Supply voltage	V	4.75	5.00		V
Supply current	I _{DD}		-	25	
Input voltage	V	0.8V _{DD}		-	V
	IL	-		V _{SS}	V
Output voltage	ОН	0.8V	-	-	
±1mA)	V _{OL}		-	V + 0.4	V
	I _{IL}		-	10	А
VCO input voltage	VCO		2.5		



NOTES:

- 1. Absolute maximum rating indicates the limit beyond which damage to the device may occur.
- Operating ratings indicate conditions for which the device is functional but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the electrical characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- 3. VCC supply pins 11, 13, and 22 must be externally wired together to prevent internal damage during VCC power on/off cycles.
- The supply current specified is the quiescent current for VCC1/VCC2 and VCC3 with RL = ∞, The supply current for VCC2 (pin 22) also depends on the output load.
- 5. Output voltage is dependent on load resistor. Test circuit uses $RL = 470\Omega$
- 6. Measure gain difference between any two amplifiers Vin = 700mVpp.
- 7. When measuring video amplifier bandwidth or pulse rise and fall times, a double sided full ground plane printed circuit board without socket is recommended. Video amplifier 50MHz cross talk test also requires this printed circuit board. The reason for a double sided full ground plane PCB is that large measurement variations occur in single sided PCBs.
- 8. Adjust input frequency from 10MHz (AV max reference level) to the -3dB frequency (f -3dB).
- Measure output levels of the other two undriven amplifiers relative to the driven amplifier to determine channel separation.
 Terminate the undriven amplifier inputs to simulate generator loading. Repeat test at fin = 50MHz for cross talk 50MHz.
- 10. A minimum pulse width of 200 ns is guaranteed for a horizontal line of 15kHz. This limit is guaranteed by design. if a lower line rate is used a longer clamp pulse may be required.
- 11. During the AC test the 4V DC level is the center voltage of the AC output signal. For example. If the output is 4Vpp the signal will swing between 2V DC and 6V DC.
- 12. These parameters are not tested on each product which is controlled by an internal qualification procedure.
- 13. The conditions blocks 03, 04, 05... etc. signify sub address'0F03, 0F04, 0F05... etc.
- 14. Sub address 0F03, 0F05 0F07: FFH
 - 0F04, 0F08 0F0C: 80H

```
RGB input = S1,
```

When the ABL input voltage is 0V, the R/G/Bs output voltage is VR/VG/VB and uses the formula ABLR = 20log (VR/V $_{cffR}$) 15. OSD TST mode = High, CLP operation off,

RGB input = S5 (frequency sweep), RGB input clamp cap = 2.1V DC, RGB clamp cap (pin 23/20/17) = Vcap voltage (7.0V), S5s frequency 1MHz → 130MHz sweep, -3dB point = 20log (V_{130MHz}/V_{1MHz}) 03, 05 — 07: FFH 04, 08 — 0C: 80H 0F: 80H

16. OSD TST mode = High, CLP operation off, RGB input clamp cap = 2.1V DC, RGB clamp cap (pin 23/20/17) = Vcap voltage (7.0V), 03, 05 — 07: FFH 04, 08 — 0C: 80H 0F: 80H R input = S5 (50MHz) CT_50M = 20log (V_{outG}/V_{outR}) or 20log (V_{outB}/V_{outR})

17. OSD TST mode = High, CLP operation off, RGB input clamp cap = 2.1V DC, RGB clamp cap (pin 23/20/17) = Vcap voltage (7.0V), 03, 05 — 07: FFH 04, 08 — 0C: 80H 0F: 80H R input = S5 (130MHz) CT_150M = 20log (V_{outG}/V_{outR}) or 20log (V_{outB}/V_{outR})



S1D2514X01

TEST SIGNAL FORMAT

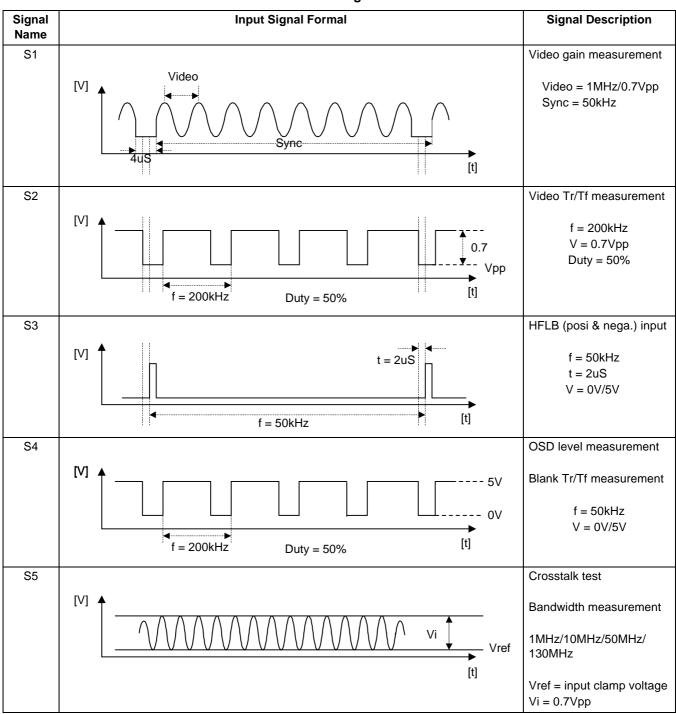


Table 10. Test Signal Format

- S1, S2 signals low level must be synchronized with the S3 signals sync. term.
- The input signal level uses the IC pin as reference.



TEST CIRCUIT

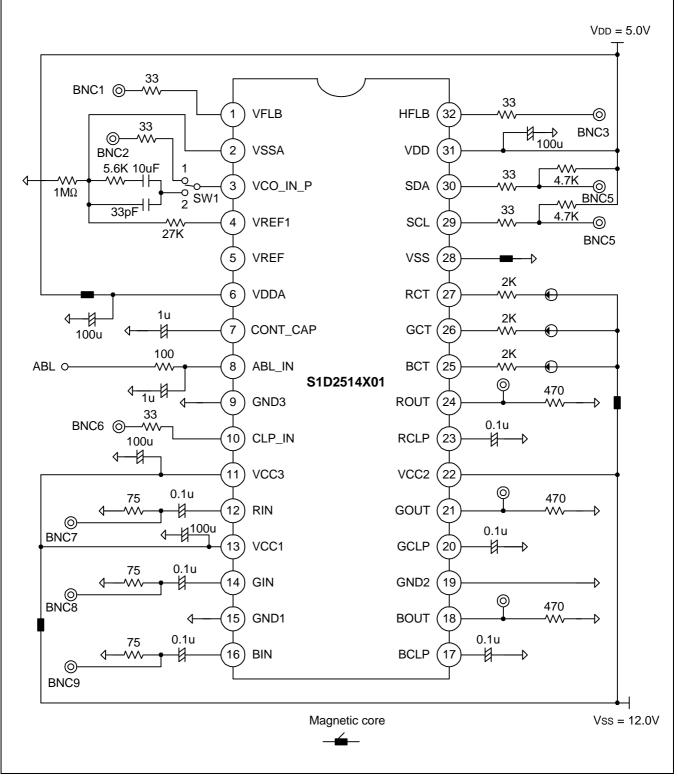


Figure 4. Test Circuit



S1D2514X01

FUNCTIONAL DESCRIPTIONS

DATA TRANSMISSION

The interface between S1D2514X01 and MCU follows the I²C protocol. After the starting pulse, the transmission takes place in the following order: Slave address with R/W bit, 2-byte register address, 2-byte data, and stop condition. an acknowledge signal is received for each byte, excluding only the start/stop condition. The 2-byte register address is composed of an 8-bit row address, and an 8-bit column address. The order of transmission for a 2-byte register address is 'Row address \rightarrow Column address'. The 2 bytes of data is because S1D2514X01 has a 16-bit base register configuration. S1D2514X01's slave address is BAh. It is BBh in read mode, and BAh in write mode.

Address Bit Pattern for Display Registers Data

(a) row address bit pattern

R3 - R0: Valid data for row address

A15	A14	A13	A12	A11	A10	A9	A8
Х	Х	Х	Х	R3	R2	R1	R0

(b) Column address bit pattern

C4 - C0: Valid data for column address

A7	A6	A5	A4	A3	A2	A1	A0
Х	Х	Х	C4	C3	C2	C1	C0

X:Don't care bit

Data Transmission Format

 $\begin{array}{l} \text{Start} \rightarrow \text{Slave address} \rightarrow \text{ACK} \rightarrow \text{Row address} \rightarrow \text{ACK} \rightarrow \text{Column address} \rightarrow \text{ACK} \\ \text{Data byte N} \rightarrow \text{ACK} \rightarrow \text{Data byte N+1} \rightarrow \text{ACK} \rightarrow \text{Stop} \end{array}$

Figure 5. Data Transmission Format at Writing Operation

 $\begin{array}{l} \text{Start} \rightarrow \text{Slave address} \rightarrow \text{ACK} \rightarrow \text{Row address} \rightarrow \text{ACK} \rightarrow \text{Column address} \rightarrow \text{ACK} \rightarrow \text{Stop} \\ \text{Start} \rightarrow \text{Slave address} \rightarrow \text{ACK} \rightarrow \text{Data byte N} \rightarrow \text{ACK} \rightarrow \text{Data byte N+1} \rightarrow \text{ACK} \rightarrow \text{Stop} \\ \end{array}$

Figure 6. Data Transmission Format at Reading Operation



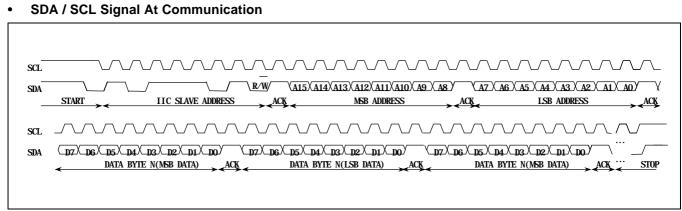


Figure 7. SDA line and SCL line (Write Operation)

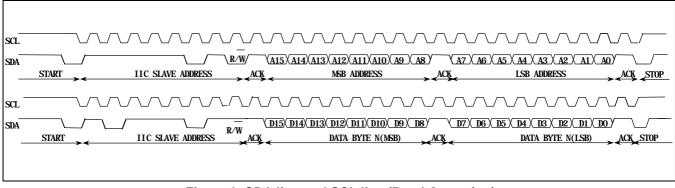


Figure 8. SDA line and SCL line (Read Operation)



Preliminary VIDEO AMP MERGED OSD PROCESSOR FOR MONITORS

MEMORY MAP

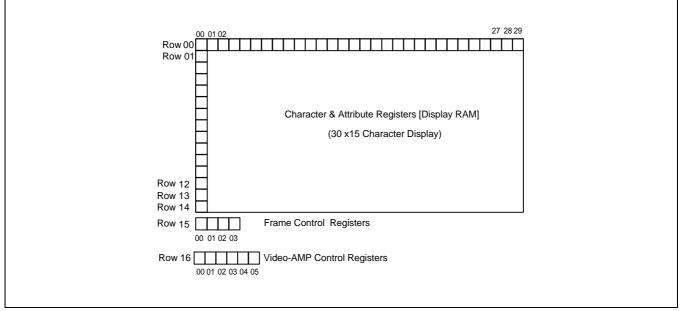


Figure 9. Memory Map of Display Registers

The display RAM's address of the row and column number are assigned in order. The display RAM is composed of 3 register groups (character & attribute register, frame control register and V-AMP control register).

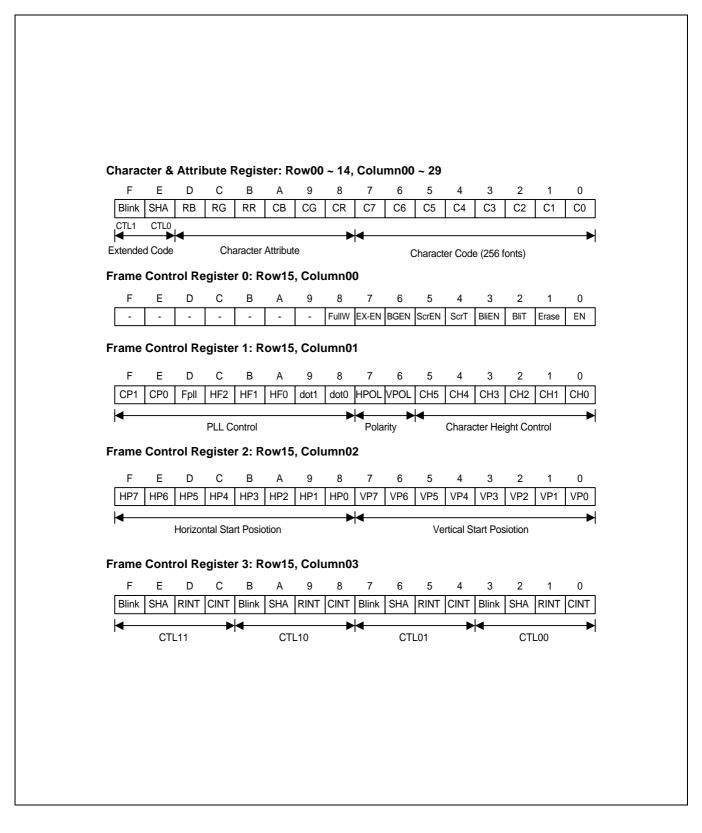
The display area in the monitor screen is 30 column \times 15 row, so the related character & attribute registers are also 30 column \times 15 row. Each register has a character address and characteristics corresponding to the display location on the screen, and one register is composed of 16 bits. The lower 8 bits select the font from the 256 ROM fonts, and the upper 8 bits give font characteristics to the selected font.

The frame control registers are in the 16th row. It controls OSD's display location, character height and scroll in units of frame.

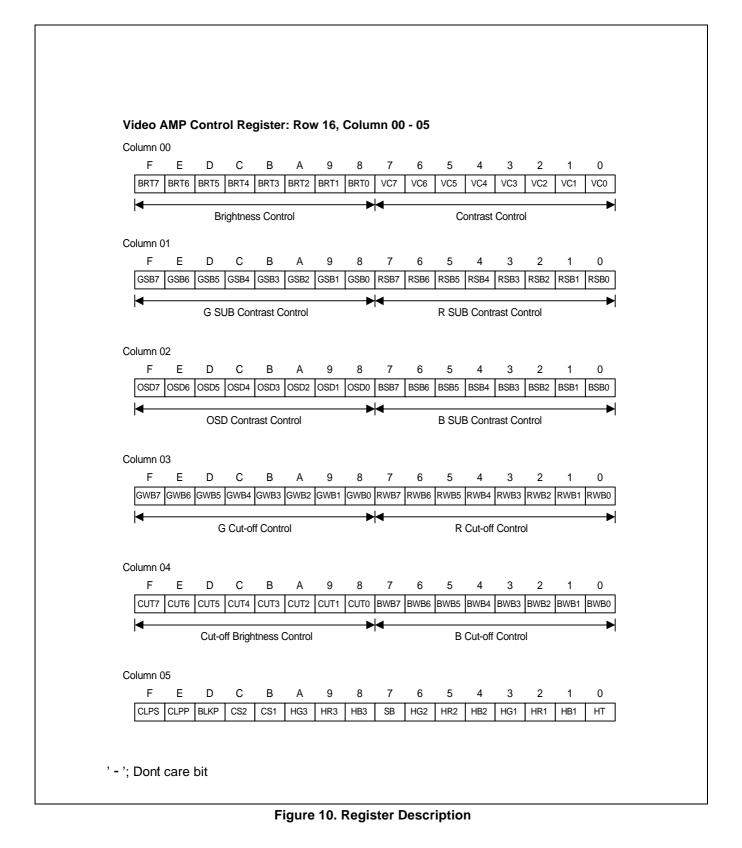
The V-AMP control registers are also located in the 17th row.



REGISTER DESCRIPTION







SAMSUNG ELECTRONICS

Registers	Bits	Description
Character &	C7 — C0	Character code address
Attribute Registers	- (This is the address of 256 ROM fonts.
(Row 00 ~ 14,	CB, CG, CR	Character color
Column 00 ~ 29)	(Bit A — 8)	The character color is chosen from 16 colors using these 3 bits and the frame control register 3s CINT bit.
	RB, RG, RR	Raster color is determined by these bits.
	(Bit D — B)	The raster color is chosen from out of 16 colors using these 3 bits and the frame control register 3s RINT bit.
	SHA / CTL0	Character shadowing / CTL0(Extended Code)
	(Bit E)	If you set the frame control register 0s EX-EN bit to '0', this bit carries out character shadowing feature.(If SHA bit is '1', the character shadowing is shown)
		If you set the frame control register 0s EX-EN bit to '1', this bit is used for extended code.
	Blink / CTL1	Character blinking / CTL1(Extended Code)
(Blt	(Blt F)	If you set the frame control register 0s EX-EN bit to '0', this bit carries out character blinking feature.(If Blink bit is '1', the character blinking feature is shown)
		If you set the frame control register 0s EX-EN bit to '1', this bit is used for extended code.

Table 11. Register Description

If you set the Frame Control Register 0s 'EX-EN' bit as '1', the Character & Attribute Registers 'SHA' and 'Blink' bits are used to call the Extended Code.

In other words, the combination of SHA and Blink bits can call four kind Extended Code 'CTL00', 'CTL01', 'CTL10' and 'CTL11', the CINT, RINT, SHA and Blink features can be carried out in a unit of character fonts.



Table 11. Register	Description	(Continued)
--------------------	-------------	-------------

Registers	Bits	Description
Frame Control	EN	OSD enable
Registers - 0 (Row15, Column00)	(Bit 0)	OSD is enabled when this bit is '1'. In other words, if this bit isn't '1'OSD is not output inspite of writing control data. We recommend that you enable the OSD after setting the control registers (such as the character & attribute register) because of video and OSD output timing.
	Erase	RAM erasing
	(Bit 1)	If this bit is '1', the RAM data (character & attribute registers) is erased. The time spent in carrying out this operation is called erasing time, which can be calculated as follows.
		Erasing time = RAM clock × 480 (RAM cell no.)
		RAM clock = 12 dot clock
		Dot clock = 1/(dot frequency)
		Dot frequency = Horizontal frequency × resolution (mode)
		Therefore, the maximum erasing time value is:
		(Erasing Time) _{MAX} = (12 × 480) / (15k × 320) = 1.2ms
	BliT	Blink time control
	(Bit 2)	If this bit is '1', blink time is 0.5sec, and if not, 1sec.
	BliEN	Blinking enable
	(Bit 3)	Blinking effect is controlled by this bit.
		If this bit is 1, blinking effect is enabled.
		If this bit is '0', a full OSD screen blinking effect is disabled.
	ScrT	Scroll time control
	(Bit 4)	If this bit is '1', scroll time is 0.5sec, and if not, 1sec.
	ScrEN	Scroll enable
	(Bit 5)	Scrolling effect is controlled by this bit. If this bit is '1', scrolling effect is enabled. You must remember that scrolling can be turned on/off only when OSD is enabled/disabled.
	BGEN	Back ground enable
	(Bit 6)	If the BGEN bit is '1' and the raster color is black, the raster is transparent.
		That is, the video back ground is shown. If not, the OSD raster covers the videos back ground. Refer to other color effect.
	EX-EN	Extended code enable
	(Bit 7)	If the EX-EN bit is '1', the Character & Attribute registers Blink, SHA bits carry out Extended Code features instead of Blink and SHA features.
	FullW	Full white pattern enable
	(Bit 8)	If the FullW bit is '1', the full white pattern is displayed in the screen.



Table 11. Register Description

Registers	Bits						
Frame Control	CH5 — CH0	Character height control					
Registers - 1		While the purpose of VZ[1:0] (vertical character height) is to control the					
Column01)		to output OSD of a uniform size even if the resolution changes. If you adjust the value in the range of $CH = 18 \sim CH = 63$, each line's repeating number					
		line is repeated. For more information on repeating number selection, refer to character height.					
		Polarity of vertical fly back signal					
	(Bit 6)						
		words, this bit is set to '1' if active high, and '0' if active low.					
	HPOL	Polarity of horizontal fly back signal If this bit is '1', HFLB's polarity is positive, and if '0', it is negative. In other					
	dat1 dat0						
	dot1, dot0 (Bit 9, 8)						
	(21:0,0)	Dot1 Dot0					
		0 0					
		0 1					
		1 0					
		As shown above, the number of dots per horizontal line is decided by a combination of these two bits.					
		Horizontal frequency					
	(Bit C — A)	This is related to the selection of DOT[1:0], so you can't numerically express the frequency range with only the HF[2:0] selection. For more					
	FPLL						
	(Bit D)	If this bit is '1', the OSD_PLL block's VCO operates at full range (4.8MHz - 96MHz). If it is '0', it operates within the region decided by the HF bit [C:A]					
		the high region, you may set the FPLL bit to '1'.					



Registers	Bits			Description			
Frame Control	CP1, CP0	Charge pu	Charge pump output current control				
Registers - 1 (Row15, Column01)	(Bit F, E)	This is the PLL block's internal phase detector output status, converted into current. Refer to PLL control.					
		CP1	CP0	Charge Pump Current			
		0	0	0.50 mA			
		0	1	0.75 mA			
		1	0	1.00 mA			
		1	1	1.25 mA			
		The outpu	ut is decide	ed by the combination of thes	e two bits.		

Table 11. Register Description (Continued)

The purpose of bits 'HPOL', and 'VPOL' is to provide flexibility when using the S1D2514X01 IC. No matter which polarity you choose for the input signal, the IC will handle them identically, so you can select active high or active low according to your convenience.



Registers	Bits	Description
Frame Control	VP7 — VP0	Vertical start position control (= $VP[7:0] \times 4$)
Registers - 2	(Bit 7 — 0)	Signifies top margin height from the V-Sync reference edge.
(Row 15,	HP7 — HP0	Horizontal start position control (= $HP[7:0] \times 6$)
Column 02)	(Bit F — 8)	Signifies delay of the horizontal display from the H-Sync reference edge to the character's 1st pixel location.
Frame Control	CTL 00	Extended code
Registers - 3 (Row 15,	(Bit 3 — 0)	In case the EX-EN bit is '1' and the Character & Attribute registers E and F bits are '0', these bits have meanings.
Column 03)		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.
	CTL 01	Extended code
	(Bit 7 — 4)	In case the EX-EN bit is 1'and the Character & Attribute registers E bit is '1' and F bit is '0', these bits have meanings.
		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.
	CTL 10	Extended code
	(Bit B — 8)	In case the EX-EN bit is '1' and the Character & Attribute registers E bit is '0' and F bit is '1', these bits have meanings.
		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.

Tabel 4. Register Description (Continued)



Tabel 4. Register Description (Continu	ed)
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Registers	Bits	Description
Frame Control	CTL 11	Extended code
Registers - 3 (Row 15,	(Bit F — C)	In case the EX-EN bit is '1' and the Character & Attribute registers E and F bits are '1', these bits have meanings.
Column 03)		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.

Registers	Bits	Description
V-AMP Control Registers - 0 (Row 16,	VC7 — VC0 (Bit7 — 0)	The contrast adjustment is made by controlling simultaneously the gain of three internal variable gain amplifiers. The contrast adjustment allows to cover a typical range of 38dB.
Column 00)	BRT7 — BRT0 (BitF — 8)	The brightness adjustment controls to add the same black level (pedestal) to the 3-channel R/G/B signals after contrast amplifier.
V-AMP Control Registers - 1 (Row 16, Column 01)	RSB7 — RSB0 (Bit7 — 0)	R channel SUB contrast control. The SUB contrast adjustment is used to adjust the white balance, and the gain of each channel is controlled. The SUB contrast adjustment allows you to cover a typical tange of 12dB.
	GSB7 — GSB0 (BitF — 8)	G channel SUB contrast control. The SUB contrast adjustment is used to adjust the white balance, and the gain of each channel is controlled. The SUB contrast adjustment allows you to cover a typical tange of 12dB.
V-AMP Control Registers - 2 (Row 16, Column 02)	BSB7 — BSB0 (Bit7 — 0)	B channel SUB contrast control. The SUB contrast adjustment is used to adjust the white balance, and the gain of each channel is controlled. The SUB contrast adjustment allows you to cover a typical tange of 12dB.
	OSD7 — OSD0 (BitF — 8)	The OSD contrast adjustment is made by controlling simultaneously the gain of three internal variable gain amplifiers. The OSD contrast adjustment allows to cover a typical range of 38dB.
V-AMP Control Registers - 3 (Row 16, Column 03)	RWB7 — RWB0 (Bit7 — 0) GWB7 — GWB0 (BitF — 8)	R channel cut-off control. The cut-off adjustment is used to adjust the raster white balance. G channel cut-off control. The cut-off adjustment is used to adjust the raster white balance.
V-AMP Control Registers - 4 (Row 16, Column 04)	BWB7 — BWB0 (Bit7 — 0) CUT7 — CUT0 (BitF — 8)	B channel cut-off control. The cut-off adjustment B used to adjust the raster white balance. The cut-off brightness adjustment is made by simultaneously controlling the external cut-off current.

Tabel 4. Register Description (Continued)



Registers	Bits				Des	scriptior	า		
V-AMP Control	HT	Video &	OSD ha	If tone er	nable.				
Registers - 5	(Bit 0)	If you se	t this bit	to '1', the	e half tor	ne functio	on is on.		
(Row 16,		Then yo	u can se	e the vid	eo signa	al & OSD	raster.		
Column 05)	HG1 — HB1	HG1 —	HB1 bit	s select	OSD ras	ter color	1 to be	half tone.	
	(Bit3 — 1)	To carry	out half	tone fun	ction, se	t the HT	bit to '1		
						OSD		Raster	
		HG1	HR1	HB1	G	R	В	Color 1	POR
		0	0	0	0	0	0	Black	0
		0	0	1	0	0	1	Blue	
		0	1	0	0	1	0	Red	
		0	1	1	0	1	1	Magenta	
		1	0	0	1	0	0	Green	
		1	0	1	1	0	1	Cyan	
		1	1	0	1	1	0	Yellow	
		1	1	1	1	1	1	White	
	HG2 — HB2 (Bit6 — 4)	HG2 ~ H To carry						'. T	1
		HG2	HR2	HB2	G	R	В	Raster Color 2	POR
		0	0	0	0	<u>к</u> 0	В 0	Black	0
		0	0	1	0	0	1	Blue	
		0	1	0	0	1	0	Red	
		0	1	1	0	1	1	Magenta	
		1	0	0	1	0	0	Green	
		1	0	1	1	0	1	Cyan	
		1	1	0	1	1	0	Yellow	
		1	1	1	1	1	1	White	
			1		L	1	1	1	1
	SB	Soft blar	king en	ahlo					
	(Bit 7)	If you se	-						

Tabel 4. Register Description (Continued)



	Bits				Des	scription	1			
Registers - 5 (Row 16,	HG3 — HB3 (BitA — 8)	To carry	out half	tone func	ction, se	t the HT	bit to '1	'.		
(NUW TO,			HR3	HB3						
		1	0		G 0	R 0		Color 3 Black		
			0	1	0	0	1	Blue		
			1	0	0	1	0	Blue		
		1	1	0	0	1	0	Magenta		
		0		0	1		0	Green		
		0	0		1	0	Ŭ	Cyan		
		0	-	0	1		0	Yellow		
			1	1		1	1			
				11						
	CS2 — CS1	Cut-off o	offset cur	rent cont	rol					
		CS2	CS1					POR		
		0				100μ				
		0	1			μA				
			0			0 A		0		
			1			50 A				
	BLKP			ntral fly b -LBs pola	•		and if '1	1', it is positive.		
	(Bit E)	Polarity of clamp pulse signal This bit has meaning only if the CLPS bit is set to '1'.								
	CLPS	Clamp pulse generation enable If this bit is '0', clamp signal is made using the HFLB signal, so there is and if '1' you must supply external clamp signal.								

Tabel 4. Register Description (Continued)



VIDEO AMP PART ADDRESS MAP

Register sub address

SUB		Function														POR		
Address [Hex]	F	Е	D	С	В	Α	9	8	7	6	5	4	3	2	1	0	Value [Hex]	
1000		Brightness control									Contrast control							
1001			SUB c	ontras	st cont	rol (G))		SUB contrast control (R)								8080	
1002			OSD	contr	ast co	ntrol			SUB contrast control (B)								8080	
1003			Cut	t-off co	ontrol	(G)			Cut-off control (R)								8080	
1004	Cut-off brightness control								Cut-off control (B)								8080	
1005	CLPS CLPP BLKP CS2 CS1 HG3 HR3 HB3 SB HG2 HR2 HB2 HG1 HR1 HB1 HT								1800									

Table 12. Video AMP Part Address Map

Contrast Register (SUB ADRS: 00H) (Vin = 0.7Vpp, bright: 80H, subcont: FFH)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	Contrast (Vpp)	Gain (dB)	int. Value (Hex)
00	0	0	0	0	0	0	0	0	0	-	
80	1	0	0	0	0	0	0	0	2.85	-	0
FF	1	1	1	1	1	1	1	1	5.2	-	
	Increment/bit								0.0223		

Brightness Register (3-ch) (SUB ADRS: 00H) (cont: 80H, subcont: 80H)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	Brightness (Vpp)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0	0.2	
80	1	0	0	0	0	0	0	0	1.5	0
FF	1	1	1	1	1	1	1	1	2.7	
	Increment/bit								0.01055	

SUB Contrast Register (R/G/B-ch) (SUB ADRS: 01/02H)

(Vin = 0.7Vpp, bright: 40H, cont: FFH)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	SUB Contrast (Vpp)	Gain (dB)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0		-	
80	1	0	0	0	0	0	0	0		-	0
FF	FF 1							1		-	
			Inc	rement	/bit						



Hex	B7	B6	B5	B4	B3	B2	B1	B0	OSD Contrast	Gain	Int. Value
									(Vpp)	(dB)	(Hex)
00	0	0	0	0	0	0	0	0	0	-	
80	1	0	0	0	0	0	0	0	3.2	-	0
FF	1	1	1	1	1	1	1	1	6.4	-	
Increment/bit									0.025		

OSD Contrast Register (SUB ADRS: 02H) (VOSD = TTL, bright: 80H, subcont: 80H)

Cut-Off Brightness Register (3-ch) (SUB ADRS: 04H)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	Cut-Off Brightness (µA)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0	0	
80	1	0	0	0	0	0	0	0	100	0
FF	1	1	1	1	1	1	1	1	200	
Increment/bit								0.781		

Cut-Off Register (R/G/B-ch) (SUB ADRS: 03/04H)

(cont = 80H, subcont: 80H)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	Cut-Off EXT (µA)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0	0	
80	1	0	0	0	0	0	0	0	300	0
FF	1	1	1	1	1	1	1	1	600	
Increment/bit								2.344		



ADDRESSING

ROM Fonts

S1D2514X01 provides 256 Rom fonts for displaying OSD Icons, which allows the use of multi-language OSD Icons. Font \$000 is reserved for blank data.

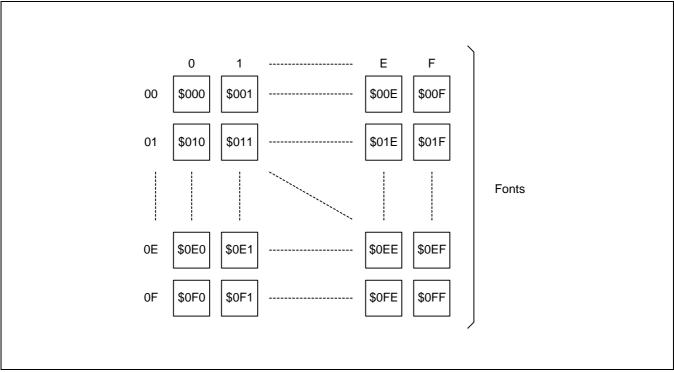


Figure 11. Composition of the ROM Fonts



COLORING

If you have an Intensity feature, the number of possible colors you can express becomes doubled. In other words, the number of colors you can represent with three colors blue, green, and red is 8 ($= 2^3$), but with the intensity feature, it is 16 ($= 2^4$).

Character Color

Character color is assinged for each font, and the 4 components for expressing a color are listed below.

Blue	Character & attribute register's CB bit[A]
Green	Character & attribute register's CG bit[9]
Red	Character & attribute register's CR bit[8]
Intensity	If the EX-EN bit is '1' and the Frame Control Register 3 CTLs CINT bit called by Character & Attribute registers Blink, SHA bits is '1', the character intensity feature is enabled.

Raster Color

Blue	Character & Attribute register's RB bit[D]
Green	Character & Attribute register's RG bit[C]
Red	Character & Attribute register's RR bit[B]
Intensity	If the EX-EN bit is '1' and the Frame Control Register 3 CTLs RINT bit called by Character & Attribute registers Blink, SHA bits is '1', the RASTER intensity feature is enabled.

According to the 'EX-EN', 'RINT' and 'CINT' bits setting, raster and character color intensity can be assigned in units of character.

Notes for When Making S1D2514X01 Fonts

Address 000h is appointed as blank data. RAM's initial values are all 0, and all bits are written as 0 when you erase the RAM, so blank data means the initial value. In other words, blank data means 'do nothing'. You don't need to write any data for the space font, except for 000h. It just needs to be an undotted area.



Other Color Effet

The Frame Control Register 0 'BGEN' bit's function is shown in the Figure below. If you set the 'BGEN' bit as '0' after selecting A's raster color as black, the raster color black will be displayed. But if you set the 'BGEN' bit as '1', after selecting B's raster color as black, the raster color black becomes invisible, so the video back ground color (gray) is displayed as if it is the raster color.

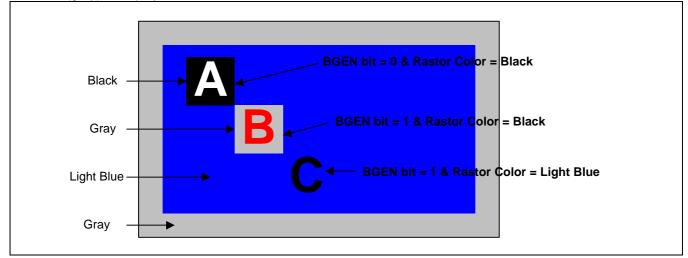


Figure 12. Color Effect by BGEN Bit



HEIGHT/POSITIONING

• Character Height

The purpose of CH[5:0] (Character Height) is to output a uniformly sized OSD even if the resolution changes. To express a Character Height of $CH = 18 \sim CH = 63$ after receiving CH[5:0]'s input from the frame control register-1, decide on each line's repeating number (Standard Height CH = 18) and repeat the lines.

The following Figure shows two examples of a height-controlled character. height control is carried out by repeating some of the lines.

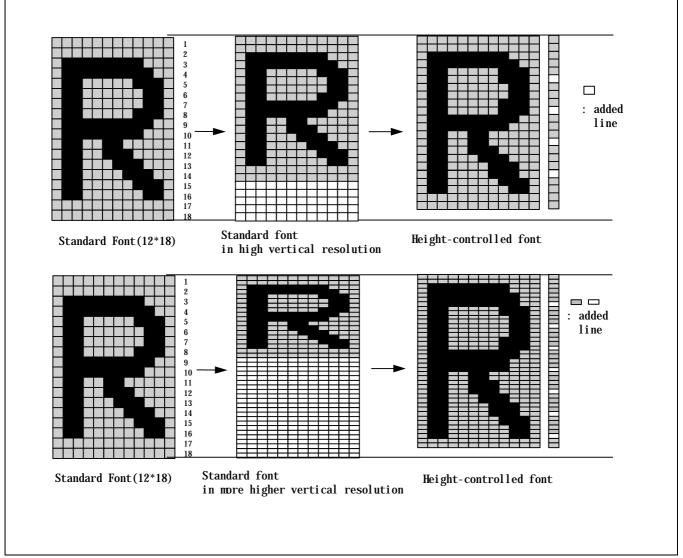


Figure 13. Character Height



Repeating line-number can be found by the following formula.

[# of the repeating lines = $2 + N \times M$], where N = 1, 2, 3, ... and M = round{14 , (CH[5:0]-18)}.

1. If CH[5:0] is greater than 32 and less than or equal to 46 (32 < CH[5:0] ≤ 46), all lines are repeated once or twice. The lines that are repeated twice are chosen by the following formula.

[# of the repeating lines = 2 + N \times M], where N = 1, 2, 3, ... and M = round {14 \leq (CH[5:0]-32)}.

2. If CH[5:0] is greater than 46 and less than or equal to 60 (46 < CH[5:0] ≤ 60), all lines are repeated two or three times. The lines that are repeated three times are chosen by the following formula.

[# of the repeating lines = 2 + N \times M], where N = 1, 2, 3, ... and M = round {14 \leq (CH[5:0]-46)}.

3. If CH[5:0] is greater than 60 and less than or equal to 64 (60 < CH[5:0] ≤ 64), all Lines are repeated three or four times. The lines that are repeated four times are chosen by the following formula.

[# of the repeating lines = 2 + N x M], where N = 1, 2, 3, ... and M = round {14 \leq (CH[5:0]-60)}.

CH's reference value is 18, and even if you input 0, it operates in the same way as when CH = 18. The repeating line-number is limited to 16. If the M value is less than or equal to 1, all lines of the standard font are repeated more than once.

Character Height	Repeating Line
CH = 18	-
CH = 19	9
CH = 20, 21	6, 13
CH = 22	5, 11, 17
CH = 23	4, 9, 14, 19
CH = 24	3, 7, 11, 15, 19, 21
CH = 25, 26, 27	3, 7, 11, 13, 15, 19, 22
CH = 28	3, 6, 9, 12, 14, 18, 20, 23, 25
CH = 29	3, 6, 9, 11, 13, 15, 18, 21, 23, 25, 26
CH = 30	3, 6, 8, 10, 12, 14, 16, 18, 20, 22, 25, 27
CH = 31	2, 5, 7, 9, 11, 13, 15, 17, 21, 23, 25, 27, 28
CH = 32, 33, 34, 35	2, 5, 7, 9, 11, 13, 15, 18, 21, 23, 25, 27, 28, 29
CH = 36	-
CH = 37	18

Table 13. Repeating Line as Controlling by CH bits



Character Height	Repeating Line (Continued)
CH = 38, 39	12, 25
CH = 40	10, 20, 30
CH = 41	8, 16, 24, 32
CH = 42	6, 12, 18, 24, 30, 36
CH = 43, 44, 45	6, 12, 18, 24, 30, 36, 41
CH = 46	4, 8, 12, 17, 21, 25, 29, 33, 37, 41
CH = 47	4, 8, 12, 16, 20, 24, 28, 32, 36, 40, 44
CH = 48	4, 8, 12, 16, 20, 23, 26, 29, 33, 37, 41, 45
CH = 49	4, 8, 12, 16, 19, 22, 25, 28, 31, 35, 39, 43, 47
CH = 50, 51, 52, 53	4, 8, 12, 15, 18, 21, 24, 27, 30, 33, 36, 40, 44, 48
CH = 54	-
CH = 55	27
CH = 56, 57	18, 36
CH = 58	14, 28, 42
CH = 59	12, 23, 34, 45
CH = 60	9, 18, 26, 34, 43, 52
CH = 61, 62, 63	8, 16, 23, 30, 37, 44, 51

Table 13. Repeating Line as Controlling by CH bits



Positioning

The frame control register-2's HP Bit [F:8] signifies delay of the horizontal display from the H-Sync reference edge to the character's 1st pixel location, and is controlled by multiplying HP [F:8]'s range value by 6. Also, VP bit[7:0] signifies the top margin height from the V-Sync reference edge, and is controlled by multiplying 4 to the VP [7:0]'s range value. Refer to the Figure shown below.

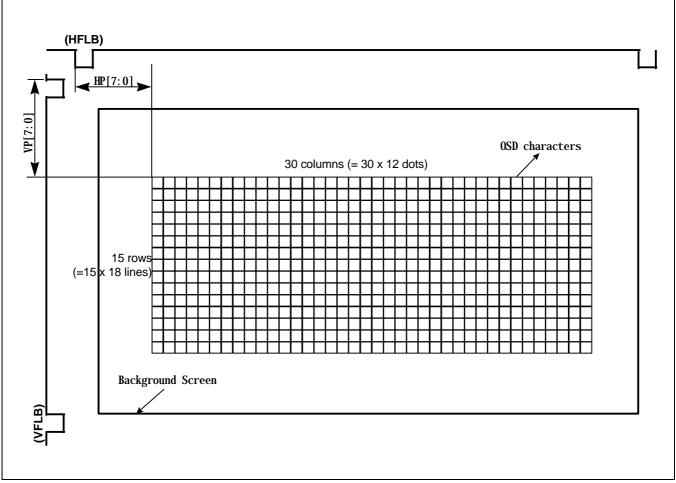


Figure 14. Frame Composition with the OSD Characters



VISUAL EFFECTS

• Shadowing

The character shadow can only be black. Character shadow is making 1 pixel to the right and below the character.

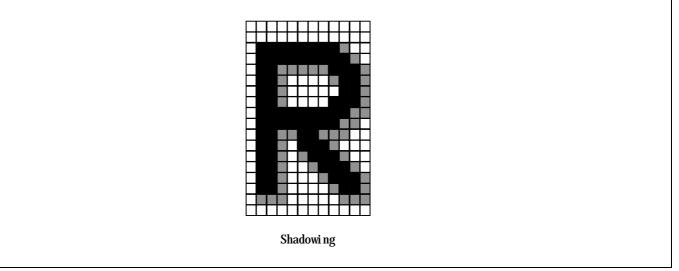


Figure 15. Character Shadowing

Scrolling

Scrolling is slowly displaying or erasing a character from the top line to the bottom. This effect makes it look as if 1 character line is scrolling up or down. asharacter line is scrolling up or down.

Figure 16. Scrolling



PLL CONTROL

Introduction

PLL (Phase Lock Loop) is feedback controlled circuit that maintains a constant phase difference between a reference signal and an oscillator output signal.

Generally, PLL is composed as follow Figure.

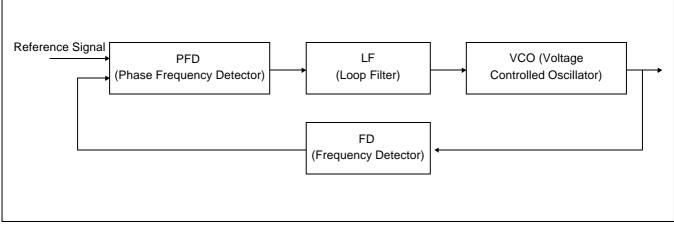


Figure 17. Block Diagram of General PLL

- PFD (Phase Frequency Detector)

PFD compares the phase of the VCO output frequency, with the phase of a reference signal frequency output pulse is generated in proportion to that phase difference.

- LF (Loop Filter)

LF smooths the output pulse of the phase detector and the resulting DC component is the VCO input.

- VCO (Voltage Controlled Oscillator)

VCO is controlled by loop filter output. The output of the VCO is fed back to the phase frequency detector input for comparison which in turn controls the VCO oscillating frequency to minimize the phase difference.

- FD (Frequency Divider)

FD divides too much different frequency that is oscillated from the VCO to compare it with reference signal frequency.



• PLL of the S1D2514X01

PLL is composed of the phase detector, charge pump, VCO, and N-divider as 4 sub-blocks.

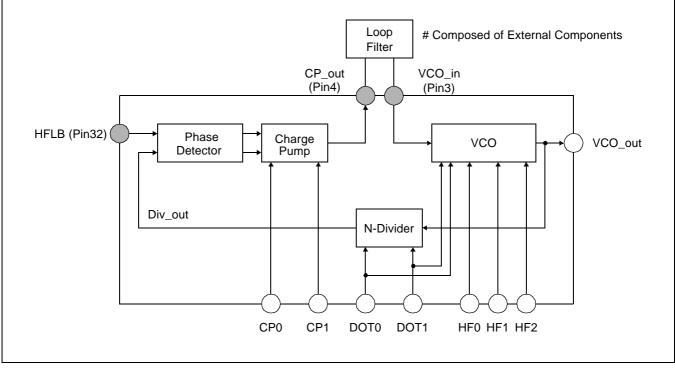


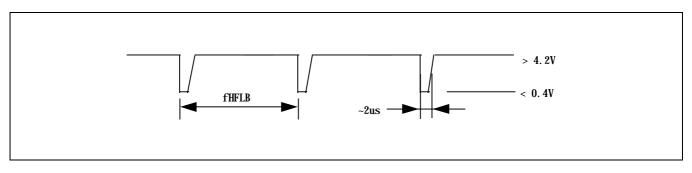
Figure 18. Block Diagram of the PLL Built in S1D2514X01

The following is the description of the input/output signals.

- HFLB (Input)

Horizontal flyback signal is refrence signal of the PLL built in S1D2514X01.

The HFLB signal's frequency range is 15 ~ 90kHz, so the PLL block must be a wide range PLL that can cover HFLB's entire frequency range.



- VCO (Input)

Error signal that passes through an external loop filter is input into VCO. Operation voltage range is 1-4V. You can raise immunity towards external noise by lowering VCO sensitivity. You can do this by making it have the maximum operation voltage range possible in the 5V power voltage.



- DOT0, 1 (Input)

Mode control signal that controls the number of dots per line in the frame control register. There are 4 modes: 320, 480, 640, and 800 dots/line.

According to your choice of mode, the OSD_PLL block's N-Divider is controlled by one of \div 320, \div 480, \div 640, or \div 800 Divider.

- HF0, 1, 2 (Input)

The horizontal Sync frequency information is received from the micro controller through the frame control registers-1's bit C-A.

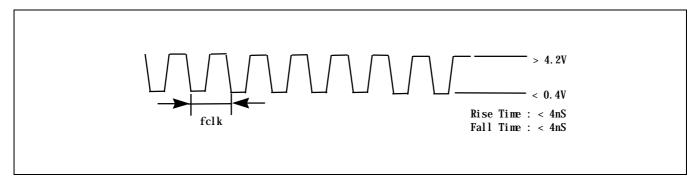
- CP0, 1 (Input)

Charge Pump's output sourcing (or sinking) current control pin. This control data is received through frame control registers-1's bits E-D.

- VCO_OUT (Output)

VCO output that becomes a system clock. It is the OSD R, G, B output signal's dot frequency, and the standard signal for OSD's various timings.

Also, it is input into the N-Divider and makes a PLL loop



- CP_OUT (Output)

Charge Pump circuit's output. input into external loop filter. It becomes one of 3 states according to the standard signal input into the phase detector (HFLB) and the divider output (Div_Out).

- HFLB Div_Out is lead: Current sink
- HFLB Lag: Current source
- HFLB In-Phase: High impedence



TUNNING FACTORS OF THE S1D2514X01 PLL

• PLL External Circuit

You may follow the recommendations for PCB art work and input/output signal characteristic improvement in recommendation.

The external circuit that has the most influence on S1D2514X01 PLL block operation is pin 3 (VCO_IN) and pin 4 (CP_OUT)'s surrounding circuit. Refer to OSD PLL block.

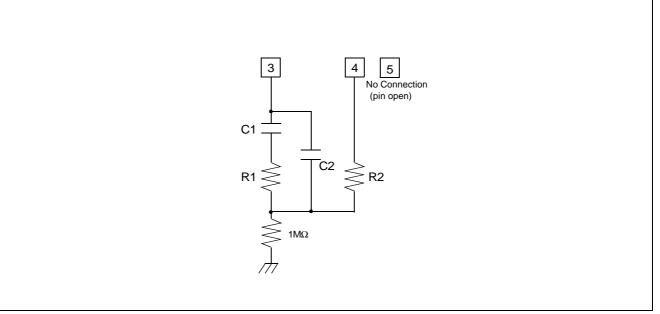


Figure 19. PLL External Circuit

Because the PLL circuit is basically a feedback circuit, there are many components that influence the characteristics. C1, C2, R1, and R2 do not have a localized effect.

As you can see, they are connected to the PLL control bits and influence the characteristics through their complicated relationships. The main functions of the time canstant and their reference values are as follows.

Time Canstant	Recommended Value	Main Function
C1	10uF	Influences the damping ratio and controls the PLL response time
R1	5.6ΚΩ(7.5ΚΩ)	Same as C1
R2	27KΩ (or 33KΩ)	Charge pump current adjustment
C2	33pF	Removes ripple caused by R-C circuit

Table 14. Main Function of Time Constant in PLL External Circuit



PLL Control Bit

After configuring an external circuit using the recommended values, carry out programming using the recommended values for frequency range and control bits given in the Table below.

Table 15. F	Recommend	Values of	PLL	Control Bit
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Register Set	PLL Control Bit								
Freq. Range	CP1	CP0	FPLL	HF2	HF1	HF0	DOT1	DOT0	Hex
Below 40kHz	0	0	0	0	1	0	1	1	0B
40 - 50kHz	1	0	0	1	0	0	1	1	93
50 - 70kHz	1	1	0	1	0	1	1	1	A7
Above 70kHz	1	1	0	1	1	1	1	1	AF

(Ref: 800 × 600, C1: 10uF, R1: 5.6K, R2: 27K, C2: 33pF)

• Locking Range

As you can see the figure below, it is 2.35V that measured voltage at pin-3 to optimize OSD quality. The proper voltage range is 1.5 - 3.25V.

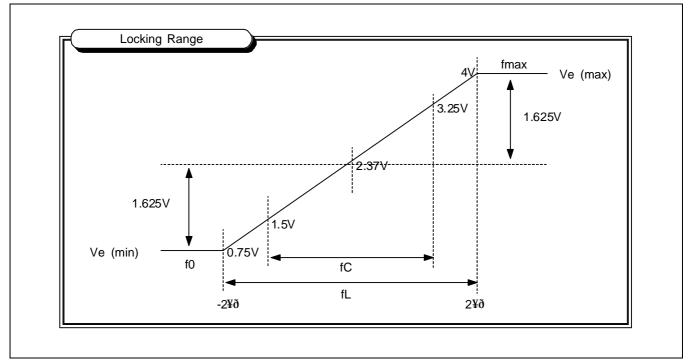


Figure 20. Locking Range



HF Bits Selection

HF bits is not selecting from out of 8 (2^3) steps uniformly, but selecting the step shown in figure below. In example, at 800 mode, there are 5 steps that the frequency range is controlled by HF bits.

DIV	DOT1	DOT0	HF2	HF1	HF0
320	0	0			
480	0	1			
640	1	0			
800	1	1			

Table 16. HF Bits Selection

After fixing time constants of the external circuit and PLL control bits except HF bits, if HF bits are stepped up, the voltage measured at pin-3 drops. On the contrary, if HF bits are stepped down, the voltage rises.

The voltage measured at pin-3 don't change by changing CP bits.

• External Register at pin-4

The external register at pin-4 is the factor that changes greatly at PLL tunning. The initial value of this external register value is decided as follows.

At first, the external register is replaced variable-register (about 50K Ω range).

and then, set the lowest PLL control bits at the lowest frequency allowed by set. and then, change variable-register to be 2.35V that optimum voltage is locking. and then, measure register value at this time.

also, set the highest PLL control bits at the highest frequency allowed by set.

and then, change variable-register to be 2.35V that optimum voltage is locking. and then, measure register value at this time.

You may decide the average of these two registers' value to initial value.



The table below shows that other factors change as changing external register's value.

Fixing Factor	Variable Factor	Change	Voltage	Current	Lock Range
Time constants of the external circuit and PLL control bits except	Rext	↑	\uparrow	\downarrow	\downarrow (shift)
		\downarrow	\downarrow	\uparrow	↑ (shift)



RECOMMENDATION

5V Power Routing

S1D2514X01's OSD part power is composed of analog VDD and digital VDD. To eliminate clock noise influence in the digital block, you need to separate the analog VDDA and digital VDD.

(BD102 use: Refer to Application Circuit)

12V Power Routing

Because S1D2514X01 is a wideband AMP of above 150MHz, 12V power significantly affects the video characteristics. The effects from the inductance and capacitance are different for each board, and , therefore, some tuning is required to obtain the optimum performance. The output power, VCC2, must be separated from VCC1 and VCC3 using a coil, which is parallel-connected to the damping resistor. The appropriate coil value is between 20uH - 200uH. Parallel-connected a variable resistor to the coil and control its resistance to obtain the optimum video waveform.

(Moreover, BD103 can tune using a coil and variable resistor to obtain the optimum video waveform. L103, R124, BD103: Refer to application circuit)

VCC1, VCC3 12V Power

Use a 104 capacitor and large capacitor greater than 470uH for the power filter capacitor.

12V Output Stage Power VCC2

Do not use the power filter capacitor.

5V Digital Power VDD

Don't use a coil or magnetic core to the VDD input. Make the power filter capacitor, an electric capacitor of greater than 50uF, single and connect it to VSS, the digital GND.

Output Stage GND2

Care must be taken during routing because it ,as an AMP output stage GND, is an important factor of video oscillation. R/G/B clamp cap and R/G/B load resistor must be placed as close as possible to the GND2 pin. GND2 must be arranged so that it has the minimum GND loop, which at one point must be connected to the main GND.

Digital GND VSS

When this is to be connected directly to the GND2, it can cause the OSD clock noise, so the loop connection should be routed as far away as possible. If the OSD clock noise affects the screen, separate VSS GND from all GND and connect it to the main board using a bead. Again, the bead connection point should be placed as far away as possible to the GND2.

Analog Block

The PLL built in to S1D2514X01 is sensitive to noise due to the wide range PLL characteristics. Therefore, you need to isolate the analog block in the following manner. First make a separate land for the analog block (pin2 - pin6)'s ground, and connect it to the main ground through a $1M\Omega$ resistor. The analog GND of both sides of a double faced PCB must be separated from the main ground. (Separate pin 2's 5V analog GND, which is the GND for OSD PLL, from the main and digital GNDs and connect it to the main GND using about $1M\Omega$ resistor. GND for pins 2 - 6 is the No. 2 VSSA GND.)



I²C Control Line (SCL, SDA Line)

 I^2C communication noise (noise generated in the OSD display pattern when data is transmitted in the I^2C line) may be generated because of an I^2C control line that passes near the analog block. The I^2C control lines near S1D2514X01 must be separated from the analog block as much as possible.

Furthermore, the I²C bus interference can be prevented by inserting a series resistor in the line.

Horizontal Flyback Signal

Display jittering can be generated if the horizontal signal (HFLB) input to S1D2514X01 is not a clean signal.

We recommend a short path and shielded cable for obtaining a clean signal.

Generally, the input horizontal signal (HFLB) is generated by using a high voltage horizontal flyback signal. The effect from the high voltage flyback signal can be reduced by separating the R115 and R117 GND, which determines the flyback signal slice level, from the transistor GND, which generates the actual S1D2514X01 input horizontal signal. Furthermore, the flyback signal sharpness must be maintained by minimizing the values of R115, R116 and R117 resistors, which set the horizontal signal slice level. values.

(R115, R116, R117: Refer to application circuit)

HFLB Input Signal Generator

You can correct the circuit by reducing the resistors that sets the slice level of the horizontal signal in the HFLBgenerating circuit.



APPLICATION BOARD CIRCUIT

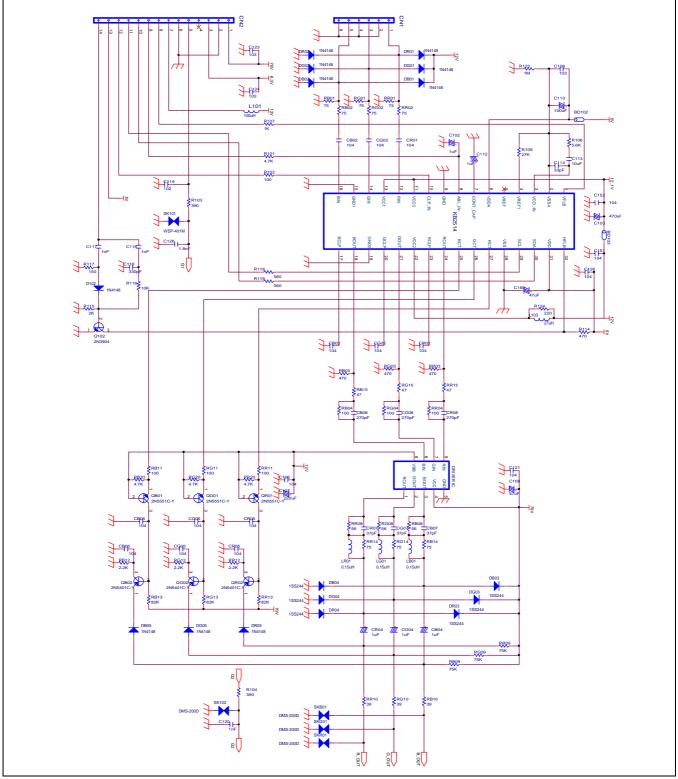


Figure 21. Application Board Circuit



TYPICAL APPLICATION CIRCUIT

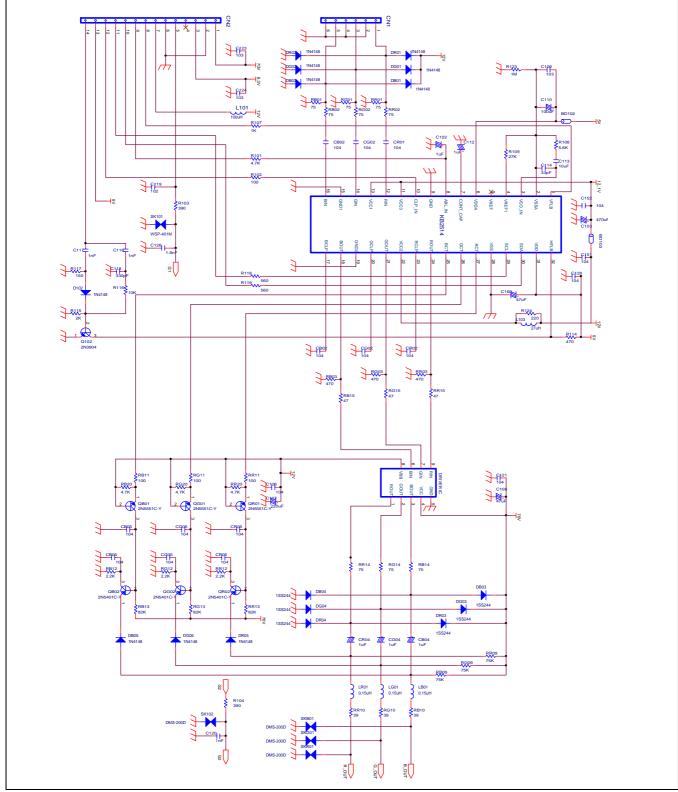


Figure 22. Typical Application Circuit



S1D2514X01

ROM FONTS

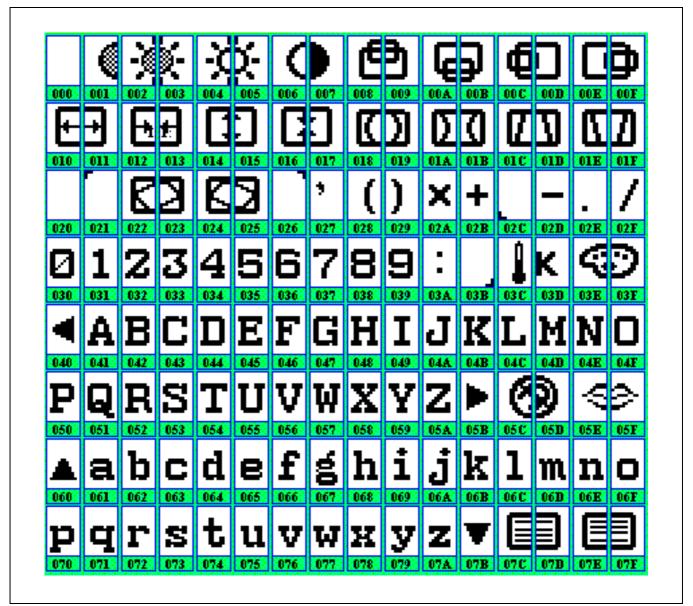


Figure 23. ROM Fonts



